PC725V0NSZX/ PC725V0YSZX

■ Features

- 1. TTL compatible output
- 2. High collector-emitter voltage (VCEO:300V)
- 3. High sensitivity (CTR:MIN. 1 000%)
- 4. Isolation voltage (Viso (rms):5kV)
- 5. Recognized by UL, file No.E64380 Approved by TÜV (VDE0884)(PC725V0YSZX)
- 6. 6-pin DIP package

■ Applications

- 1. Home appliances
- 2. Programmable controllers
- 3. Peripheral equipment of personal computers

■ Model Line-up

Model No	* Safty St App	tandard roval	Daalzaga	Packing	
Model No.	UL	TÜV (VDE0884)	Package		
PC725V0NSZX	0	_	DIP	Sleeve	
PC725V0YSZX	0	0	DIP	Sieeve	

^{*} Application Model No. PC725V

■ Absolute Maximum Ratings

(1a=25°C,
	Unit

Parameter		Symbol	Rating	Unit
	Forward current	IF	50	mA
Input	*1 Peak forward current	IFM	1	A
mput	Reverse voltage	V_R	6	V
	Power dissipation	P	70	mW
	Collector-emitter voltage	Vceo	300	V
Output	Collector-base voltage	Vcbo	300	V
	Emitter-base voltage	VEBO	6	V
	Collector current	Ic	150	mA
	Collector current (reverse)	-Ic	10	mA
	Collector power dissipation	Pc	300	mW
	Total power dissipation	Ptot	350	mW
	*2 Isolation voltage	$V_{iso\;(rms)}$	5	kV
Operating temperature		Topr	-25 to +100	°C
	Storage temperature	Tstg	-40 to +125	°C
	*3 Soldering temperature	Tsol	260	°C

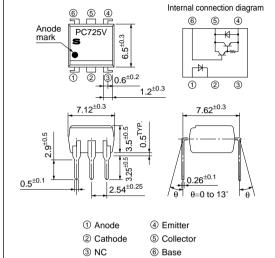
^{*1} Pulse width≤100µs, Duty ratio=0.001

High Sensitivity and High Collector-emitter Voltage Type Photocoupler

■ Outline Dimensions



(Unit: mm)



^{*2 40} to 60% RH, AC for 1 min

^{*3} For 10 s

■ Electro	Electro-optical Characteristics (Ta=25°C)								
	Parameter Sys			Conditions	MIN.	TYP.	MAX.	Unit	
	Forward voltage		VF	I _F =10mA	-	1.2	1.4	V	
Input	Peak forward voltage	e	V _{FM}	I _{FM} =0.5A	-	-	3	V	
прис	Reverse current		IR	V _R =4V	-	_	10	μΑ	
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF	
Output	Collector dark current		Iceo	Vce=200V, I _F =0, R _{BE} =∞	_	_	10-6	A	
	Collector current		Ic	I _F =1mA, V _{CE} =2V, R _{BE} =∞	10	40	150	mA	
	Collector-emitter saturation voltage		V _{CE(sat)}	I _F =20mA, I _C =100mA, R _{BE} =∞	-	_	1.2	V	
Transfer	Isolation resistance		Riso	DC500V, 40 to 60%RH	5×10 ¹⁰	1011	_	Ω	
charac-	Floating capacitance		Cf	V=0, f=1MHz	_	0.6	1.0	pF	
teristics	Cut-off frequency		fc	Vce=2V, Ic=20mA, Rl=100Ω, RBE=∞, -3dB	1	7	_	kHz	
	Dogmongo timo	Rise time	tr	Vce=2V, Ic=20mA	-	100	300	μs	
	Response time	Fall time	tf	R _L =100Ω, R _{BE} =∞	_	20	100	μs	

Fig.1 Forward Current vs. Ambient Temperature

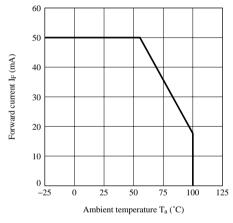


Fig.2 Collector Power Dissipation vs. Ambient Temperature

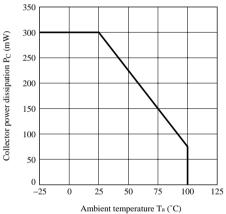


Fig.3 Peak Forward Current vs. Duty Ratio

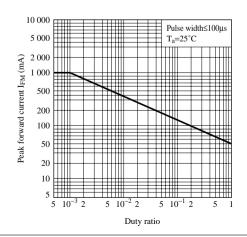


Fig.4 Forward Current vs. Forward Voltage

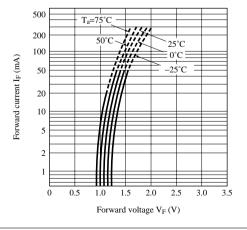


Fig.5 Current Transfer Ratio vs. Forward Current

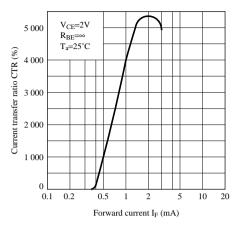


Fig.7 Relative Current Transfer Ratio vs.
Ambient Temperature

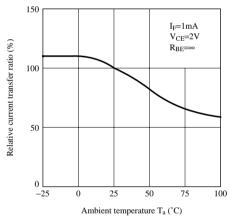


Fig.9 Collector Dark Current vs. Ambient Temperature

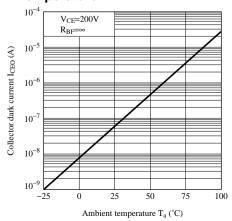


Fig.6 Collector Current vs. Collector-emitter Voltage

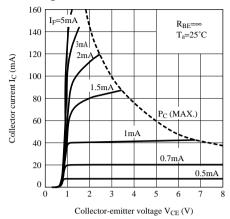


Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

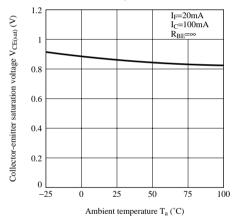


Fig.10 Response Time vs. Load Resistance

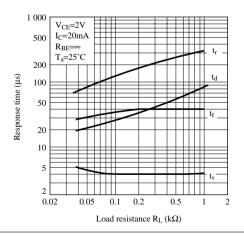
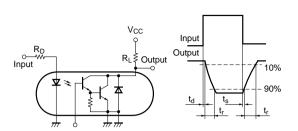


Fig.11 Test Circuit for Response Time

Fig.12 Frequency Response



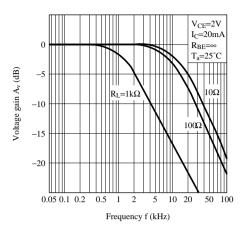
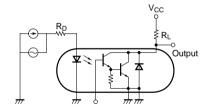


Fig.13 Test Circuit for Frequency Response



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- Observe the following points when using any devices in this publication. SHARP takes no responsibility for damage caused by improper use of the devices which does not meet the conditions and absolute maximum ratings to be used specified in the relevant specification sheet nor meet the following conditions:
 - (i) The devices in this publication are designed for use in general electronic equipment designs such as:
 - Personal computers
 - Office automation equipment
- Telecommunication equipment [terminal]
- Test and measurement equipment
- Industrial control
- Audio visual equipment
- Consumer electronics
- (ii) Measures such as fail-safe function and redundant design should be taken to ensure reliability and safety when SHARP devices are used for or in connection with equipment that requires higher reliability such as:
- Transportation control and safety equipment (i.e., aircraft, trains, automobiles, etc.)
- Traffic signals
- Gas leakage sensor breakers
- Alarm equipment
- Various safety devices, etc.
- (iii) SHARP devices shall not be used for or in connection with equipment that requires an extremely high level of reliability and safety such as:
- Space applications
- Telecommunication equipment [trunk lines]
- Nuclear power control equipment
- Medical and other life support equipment (e.g., scuba).
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PC725V0NIZX/ PC725V0NIPX

■ Features

- 1. TTL compatible output
- 2. High collector-emitter voltage (VCEO:300V)
- 3. High sensitivity (CTR:MIN. 1 000%)
- 4. Isolation voltage (Viso (rms):5kV)
- 5. Recognized by UL, file No.E64380
- 6. 6-pin DIP package (Lead forming type)

■ Applications

- 1. Home appliances
- 2. Programmable controllers
- 3. Peripheral equipment of personal computers

■ Model Line-up

Model No.	* Safty St Appr		Doolsogo	Packing	
wiodei No.	UL	TÜV (VDE0884)	Package	racking	
PC725V0NIZX	0	-	Surface	Sleeve	
PC725V0NIPX	0	_	Mount	Taping	

^{*} Application Model No. PC725V

■ Absolute Maximum Ratings

(Tr	_25	00
(12	1=23	·

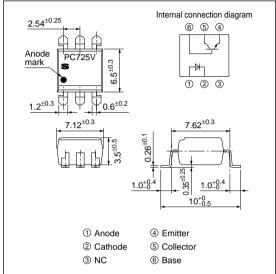
	Parameter	Symbol	Rating	Unit
Input	Forward current	IF	50	mA
	*1 Peak forward current	IFM	1	A
Input	Reverse voltage	V_R	6	V
	Power dissipation	P	70	mW
	Collector-emitter voltage	Vceo	300	V
Output	Collector-base voltage	Vcbo	300	V
	Emitter-base voltage	VEBO	6	V
	Collector current	Ic	150	mA
	Collector current (reverse)	-Ic	10	mA
	Collector power dissipation	Pc	300	mW
Total power dissipation		Ptot	350	mW
*2 Isolation voltage		Viso (rms)	5	kV
Operating temperature		Торг	-25 to +100	°C
	Storage temperature	Tstg	-40 to +125	°C
	*3 Soldering temperature	Tsol	260	°C

^{*1} Pulse width≤100µs, Duty ratio=0.001

High Sensitivity and High Collector-emitter Voltage Type Photocoupler

■ Outline Dimensions





^{*2 40} to 60% RH. AC for 1 min

^{*3} For 10 s

■ Electro	■ Electro-optical Characteristics (Ta=25°C)								
	Parameter			Conditions	MIN.	TYP.	MAX.	Unit	
	Forward voltage		V _F	I _F =10mA	_	1.2	1.4	V	
Input	Peak forward voltage		V _{FM}	I _{FM} =0.5A	ı	-	3	V	
Input	Reverse current		IR	$V_R=4V$	_	_	10	μΑ	
	Terminal capacitance		Ct	V=0, f=1kHz	-	30	250	pF	
Output	Collector dark current		Iceo	Vce=200V, I _F =0, R _{BE} =∞	-	_	10-6	A	
	Collector current		Ic	I _F =1mA, V _{CE} =2V, R _{BE} =∞	10	40	150	mA	
	Collector-emitter saturation voltage		V _{CE(sat)}	I _F =20mA, I _C =100mA, R _{BE} =∞	1	_	1.2	V	
Transfer	Isolation resistance		Riso	DC500V, 40 to 60%RH	5×10 ¹⁰	1011	_	Ω	
charac-	Floating capacitance		Cf	V=0, f=1MHz	-	0.6	1.0	pF	
teristics	Cut-off frequency		fc	Vce=2V, Ic=20mA, Rl=100Ω, RBE=∞, -3dB	1	7	_	kHz	
	Response time	Rise time	tr	Vce=2V, Ic=20mA	ı	100	300	μs	
	Response time	Fall time	tf	$R_L=100\Omega$, $R_{BE}=\infty$		20	100	μs	

Fig.1 Forward Current vs. Ambient Temperature

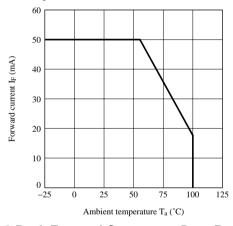


Fig.2 Collector Power Dissipation vs. Ambient Temperature

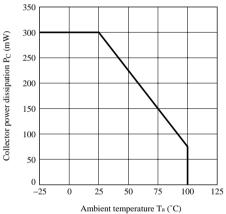


Fig.3 Peak Forward Current vs. Duty Ratio

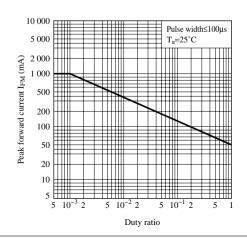


Fig.4 Forward Current vs. Forward Voltage

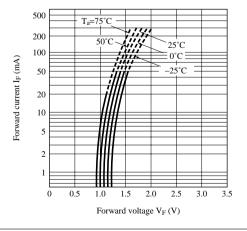


Fig.5 Current Transfer Ratio vs. Forward Current

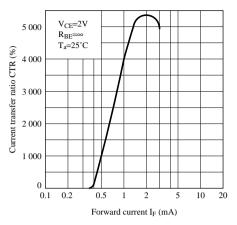


Fig.7 Relative Current Transfer Ratio vs.
Ambient Temperature

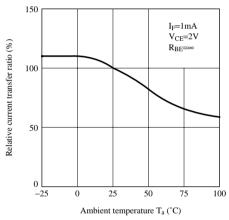


Fig.9 Collector Dark Current vs. Ambient Temperature

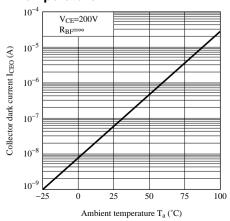


Fig.6 Collector Current vs. Collector-emitter Voltage

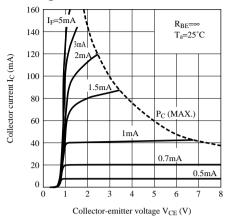


Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

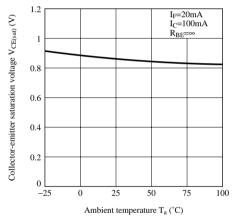


Fig.10 Response Time vs. Load Resistance

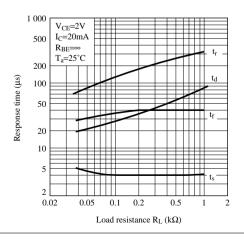
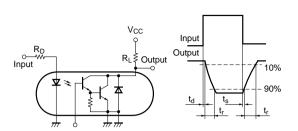


Fig.11 Test Circuit for Response Time

Fig.12 Frequency Response



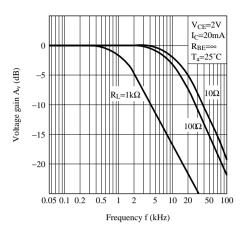
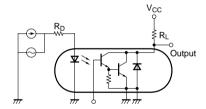


Fig.13 Test Circuit for Frequency Response



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- Alarm equipment
- Various safety devices, etc.
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SHARP PC725V0YUZX

PC725V0YUZX

■ Features

- 1. TTL compatible output
- 2. High collector-emitter voltage (VcEo:300V)
- 3. High sensitivity (CTR:MIN. 1 000%)
- 4. Isolation voltage (Viso (rms):5kV)
- 5. Recognized by UL, file No.E64380 Approved by TÜV (VDE0884)
- 6. 6-pin DIP package (Lead forming type)
- 7. Sleeve packing

■ Applications

- 1. Home appliances
- 2. Programmable controllers
- 3. Peripheral equipment of personal computers

■ Absolute Maximum Ratings

(To-	_259	(1)
(Ia	=23	C)

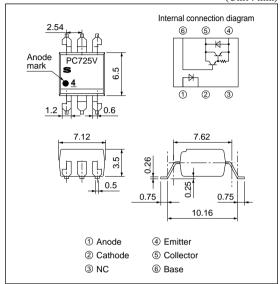
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	Parameter	Symbol	Rating	Unit		
	Forward current	IF	50	mA		
Input	*1 Peak forward current	IFM	1	A		
mput	Reverse voltage	V_R	6	V		
	Power dissipation	P	70	mW		
Outout	Collector-emitter voltage	Vceo	300	V		
	Collector-base voltage	Vcbo	300	V		
	Emitter-base voltage	VEBO	6	V		
Output	Collector current	Ic	150	mA		
	Collector current (reverse)	-Ic	10	mA		
	Collector power dissipation	Pc	300	mW		
Total power dissipation		Ptot	350	mW		
*2 Isolation voltage		Viso (rms)	5	kV		
	Operating temperature	Topr	-25 to +100	°C		
	Storage temperature	Tstg	-40 to +125	°C		
	*3 Soldering temperature	Tsol	260	°C		

^{*1} Pulse width≤100µs, Duty ratio=0.001

High Sensitivity and High Collector-emitter Voltage Type Photocoupler

■ Outline Dimensions





^{*2 40} to 60% RH, AC for 1 min

^{*3} For 10 s

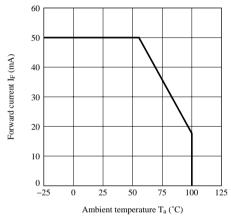
■ Electro	■ Electro-optical Characteristics (Ta=25°C)							
	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit	
	Forward voltage	VF	I _F =10mA	-	1.2	1.4	V	
Input -	Peak forward voltage	V _{FM}	I _{FM} =0.5A	-	-	3	V	
	Reverse current	IR	V _R =4V -		-	10	μΑ	
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF	
Output	Collector dark current	Iceo	Vce=200V, I _F =0, R _{BE} =∞	_	_	10-6	A	
	Collector current	Ic	I _F =1mA, V _{CE} =2V, R _{BE} =∞	10	40	150	mA	
	Collector-emitter saturation voltage	V _{CE(sat)}	I _F =20mA, I _C =100mA, R _{BE} =∞	-	_	1.2	V	
Transfer	Isolation resistance	Riso	DC500V, 40 to 60%RH	5×10 ¹⁰	1011	_	Ω	
charac-	Floating capacitance	Cf	V=0, f=1MHz	-	0.6	1.0	pF	
teristics	Cut-off frequency	fc	Vce=2V, Ic=20mA, Rl=100Ω, RBE=∞, -3dB	1	7	_	kHz	

Vce=2V, Ic=20mA

 $R_L=100\Omega$, $R_{BE}=\infty$

Fig.1 Forward Current vs. Ambient Temperature

Response time



Rise time

Fall time

 $t_{\rm r}$

tf

Fig.2 Collector Power Dissipation vs. Ambient Temperature

100

20

300

100

μs

μs

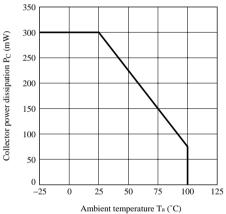


Fig.3 Peak Forward Current vs. Duty Ratio

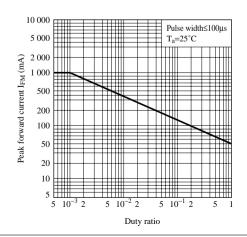
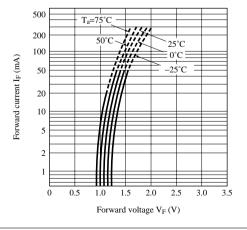


Fig.4 Forward Current vs. Forward Voltage



PC725V0YUZX

Fig.5 Current Transfer Ratio vs. Forward Current

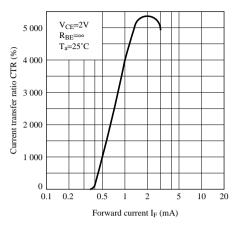


Fig.7 Relative Current Transfer Ratio vs.
Ambient Temperature

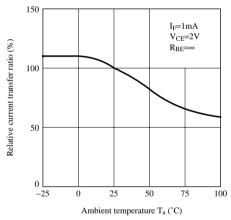


Fig.9 Collector Dark Current vs. Ambient Temperature

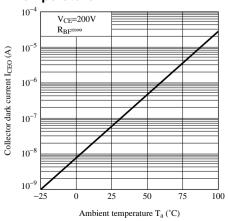


Fig.6 Collector Current vs. Collector-emitter Voltage

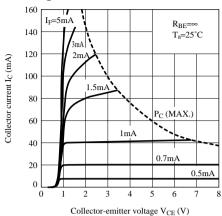


Fig.8 Collector - emitter Saturation Voltage vs. Ambient Temperature

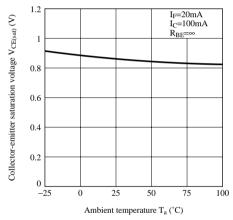
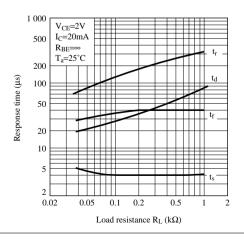


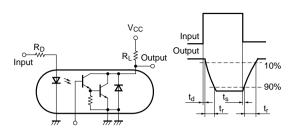
Fig.10 Response Time vs. Load Resistance



PC725V0YUZX

Fig.11 Test Circuit for Response Time

Fig.12 Frequency Response



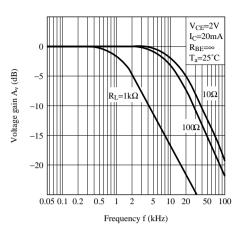
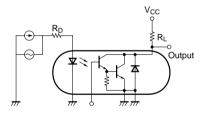


Fig.13 Test Circuit for Frequency Response



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